



Product Change Notification

Change Notification #: 114477 - 00
Change Title: Intel® NUC Kit, NUC6i3SYH,
Intel® NUC Kit, NUC6i3SYK,
PCN 114477-00, Product Design, Product
Material,
BIOS Update and Component Change
Date of Publication: March 18, 2016

Key Characteristics of the Change:

Product Design, Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Apr 11, 2016
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Description of Change to the Customer:

The Intel® NUC Kit, NUC6i3SYH and Intel® NUC Kit, NUC6i3SYK SKUs listed in the products affected table below will have the following change.

1. The BIOS will be updated from SY0024 to SY0039. To access the release notes or get a copy of the BIOS for evaluation, go to <http://downloadcenter.intel.com>.
2. The capacitors at locations SC181, SC190, and SC282 will be changed from 22uF to 47uF to improve memory compatibility.

Customer Impact of Change and Recommended Action:

It is recommended that customers evaluate this new BIOS to ensure a smooth transition.

These change has been thoroughly evaluated to ensure that there are no quality or reliability implications to our customers.

Intel validation of a new board revision does not include testing with older versions of BIOS. This change is not expected to cause a change to the Microsoft Windows* operating system's software driver stack.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change SA	Pre Change AA	Post Change SA	Post Change AA
BOXNUC6I3SYH	943209	H87086-502	H81132-502	H87086-503	H81132-503
BOXNUC6I3SYK	943211	H87085-502	H81132-502	H87085-503	H81132-503
BOXNUC6I3SYKL	946878	H95044-502	H81132-502	H95044-503	H81132-503
BOXNUC6I3SYHL	946884	H95045-502	H81132-502	H95045-503	H81132-503

PCN Revision History:**Date of Revision:**

March 18, 2016

Revision Number:

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Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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